



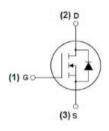
MJ N-Channel Enhancement Mode Power MOSFET

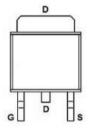
Description

The MJ6020K uses advanced trench technology and design to provide excellent $R_{\text{DS(ON)}}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- ♦ $V_{DS} = 60V, I_{D} = 20A$ $R_{DS(ON)} < 44mΩ @ V_{GS} = 10V$
- ♦ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high EAs
- ◆ Excellent package for good heat dissipation
- ◆ Special process technology for high ESD capability



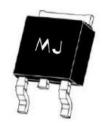


Application

◆ Power switching application

Uninterruptible power supply

Hard switched and high frequency circuits



Schematic diagram

Marking and pin assignment

TO-252-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ6020K	MJ6020K	TO-252-2L	ii ii	-	9

Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	60	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lD	20	А
Drain Current-Continuous(Tc =100°C)	ID(100°C)	14	А
Pulsed Drain Current	Ірм	60	А
Maximum Power Dissipation	Po	40	W
Derating factor		0.27	W/°C
Single pulse avalanche energy (Note 5)	Eas	72	mJ
Operating Junction and Storage Temperature Range	TJ,TsTG	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	3.7	°C/W
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Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =250μA	60	-	-	V
Zero Gate Voltage Drain Current	loss	V _{DS} =60V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	'					
Gate Threshold Voltage	VGS(th)	V _{DS} =V _{GS} ,I _D =250μA	1.0	2.0	3.0	V
Drain-Source On-State Resistance	RDS(ON)	V _{GS} =10V, I _D =20A	-	37	44	mΩ
Forward Transconductance	G FS	V _{DS} =5V,I _D =4.5A	11	-	-	S
Dynamic Characteristics (Note 4)	1					1
Input Capacitance	Clss		-	500	-	PF
Output Capacitance	Coss	V _{DS} =30V,V _{GS} =0V F=1.0MHz	-	60	-	PF
Reverse Transfer Capacitance	Crss		-	25 - PI		PF
Switching Characteristics (Note 4)						ı
Turn-on Delay Time	t _{d(on)}		-	5	-	nS
Turn-on Rise Time	tr	V _{DD} =30V,I _D =2A,R _L =6.7Ω	-	2.6	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =3Ω	-	16.1	-	nS
Turn-Off Fall Time	t f	-	-	2.3	-	nS
Total Gate Charge	Qg		-	14	-	nC
Gate-Source Charge	Qgs	V _{DS} =30V,I _D =4.5A V _{GS} =10V	-	2.9	-	nC
Gate-Drain Charge	Q _{gd}	-	-	5.2	-	nC
Drain-Source Diode Characteristics	I					
Diode Forward Voltage (Note 3)	VsD	V _{GS} =0V,I _S =20A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	20	А
Reverse Recovery Time	trr	TJ=25°C, IF=20A	-	35	-	nS
Reverse Recovery Charge	Qrr	di/dt=100A/µs (Note 3)	-	53	-	nC
Forward Turn-On Time	ton	Intrinsic turn-on time is ne	aliaiblo(tu	rn on is d	ominated b	

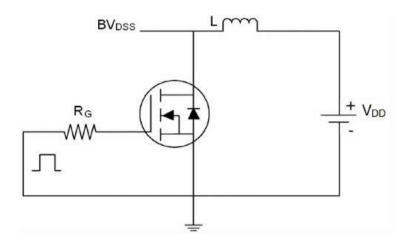
Notes

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production

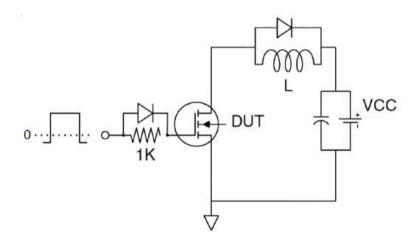




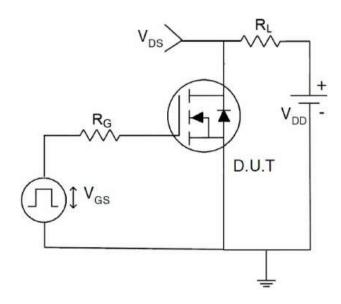
Test circuit



Eas test Circuit



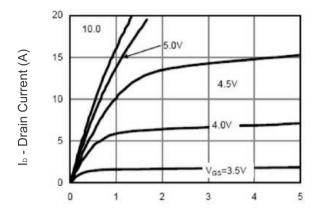
Gate charge test Circuit

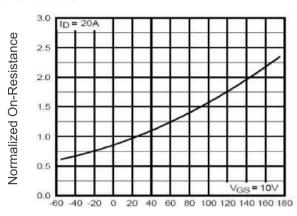


Switch Time Test Circuit



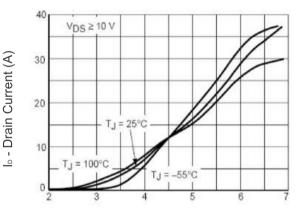
Typical Electrical and Thermal Characteristics (Curves)

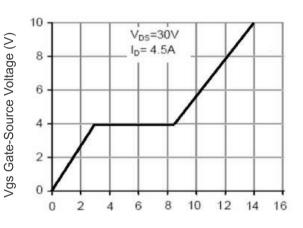




Vds Drain-Source Voltage (V)
Figure 1 Output Characteristics

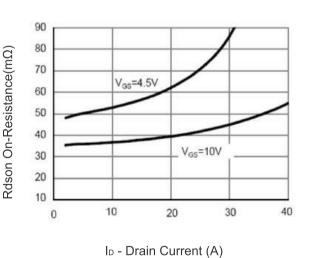
TJ -Junction Temperature(°C)
Figure 4 Rdson-Junction Temperature





Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

Qg Gate Charge (nC)
Figure 5 Gate Charge



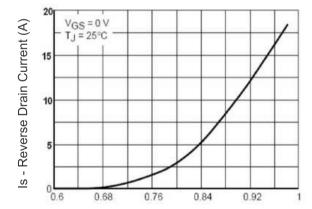
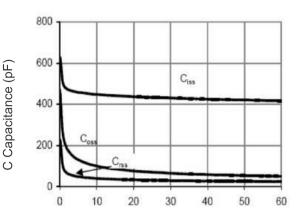


Figure 3 Rdson- Drain Current

Vsd Source-Drain Voltage (V)
Figure 6 Source- Drain Diode Forward







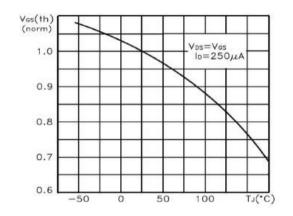
BV_{DSS} (norm) V_{OS}=0 I_D=250μA 1.2 1.1 1.0 0.9 0.8 -50 0 50 100 T_J(*C)

Vds Drain-Source Voltage (V)

Figure 7 Capacitance vs Vds

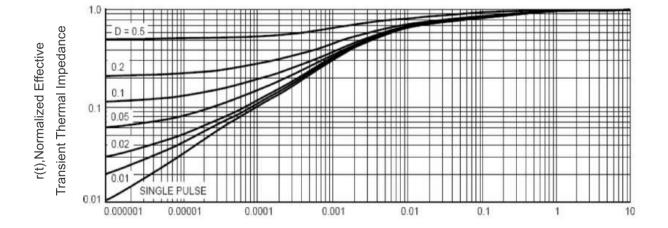
V_{GS} = 20 V SINGLE PULSE T_C = 25°C 10 μs 10 μs

T_J-Junction Temperature (°C)
Figure 9 BVpss vs Junction Temperature



Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area

T_J-Junction Temperature (°C)
Figure 10 V_{GS(th)} vs Junction Temperature



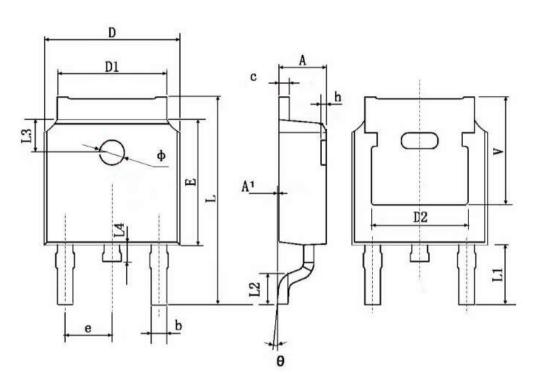
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-252 Package Information



Complete	Dimensions	In Millimeters	Dimension	s In Inches
Symbol	Min.	Max.	Min.	Max.
Α	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.8	30 TYP.	0.190 TYP.	
E	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900	TYP.	0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600	TYP.	0.063	TYP.
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0 °	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211	TYP.





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